

UWG

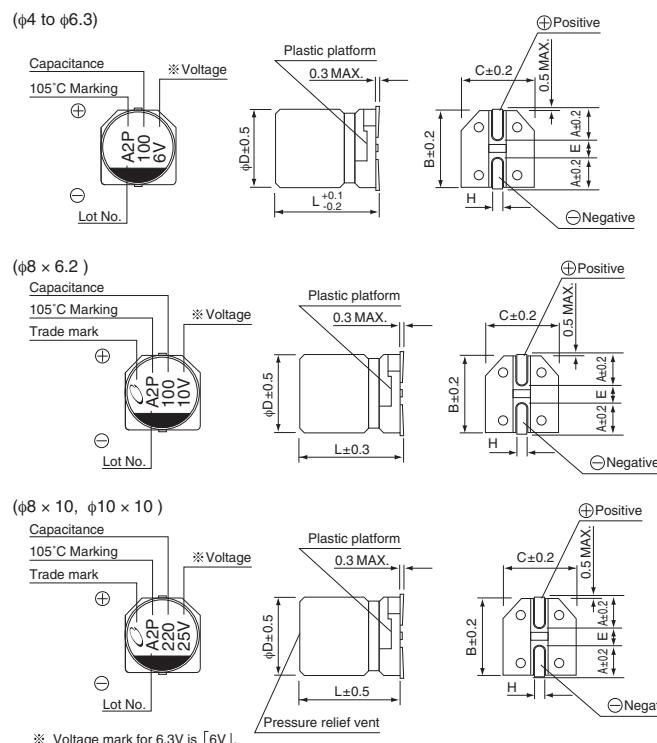
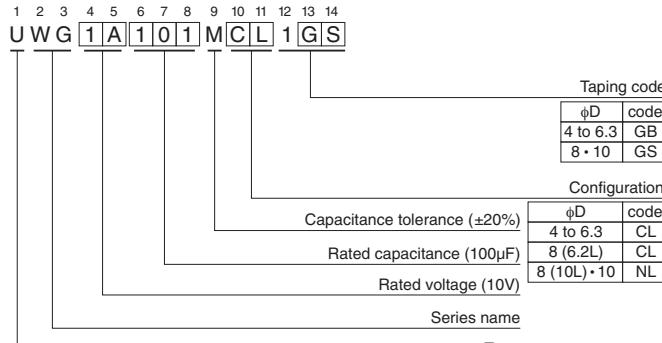
Chip Type, Low Impedance



- Chip type, operating over wide temperature range of -55 to +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU).

**■ Specifications**

Item	Performance Characteristics																											
Category Temperature Range	-55 to +105°C																											
Rated Voltage Range	6.3 to 50V																											
Rated Capacitance Range	1 to 1500μF																											
Capacitance Tolerance	±20% at 120Hz, 20°C																											
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01CV or 3 (μA), whichever is greater.																											
Tangent of loss angle (tan δ)	<table border="1"> <thead> <tr> <th>Rated voltage (V)</th> <th>6.3</th> <th>10</th> <th>16</th> <th>25</th> <th>35</th> <th>50</th> </tr> </thead> <tbody> <tr> <td>tan δ (MAX.)</td> <td>0.26</td> <td>0.19</td> <td>0.16</td> <td>0.14</td> <td>0.12</td> <td>0.12</td> </tr> </tbody> </table>							Rated voltage (V)	6.3	10	16	25	35	50	tan δ (MAX.)	0.26	0.19	0.16	0.14	0.12	0.12							
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Endurance	<p>The specifications listed at right shall be met when the capacitors are restored to 20°C after the rated voltage is applied for 1000 hours at 105°C.</p> <table border="1"> <thead> <tr> <th>Capacitance change</th> <th>Within ±20% of the initial capacitance value</th> </tr> </thead> <tbody> <tr> <td>tan δ</td> <td>200% or less than the initial specified value</td> </tr> <tr> <td>Leakage current</td> <td>Less than or equal to the initial specified value</td> </tr> </tbody> </table>							Capacitance change	Within ±20% of the initial capacitance value	tan δ	200% or less than the initial specified value	Leakage current	Less than or equal to the initial specified value															
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Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.																											
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.																											
Marking	Black print on the case top.																											

■ Chip Type**Type numbering system (Example : 10V 100μF)**

ØD × L	4 × 5.4	5 × 5.4	6.3 × 5.4	8 × 6.2	8 × 10	10 × 10
A	1.8	2.1	2.4	3.3	2.9	3.2
B	4.3	5.3	6.6	8.3	8.3	10.3
C	4.3	5.3	6.6	8.3	8.3	10.3
E	1.0	1.3	2.2	2.3	3.1	4.5
L	5.4	5.4	5.4	6.2	10	10
H	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.8 to 1.1	0.8 to 1.1

● Dimension table in next page.

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■ Dimensions

Cap. (μF)	V	6.3			10			16		
		Code	0J		1A		1C		60	
10	100							4 × 5.4	3.0	60
22	220	4 × 5.4	3.0	60				5 × 5.4	1.8	95
33	330				5 × 5.4	1.8	95			
47	470	5 × 5.4	1.8	95				6.3 × 5.4	1.0	140
68	680	6.3 × 5.4	1.0	140				8 × 6.2	0.4	230
100	101	6.3 × 5.4	1.0	140	8 × 6.2	0.4	230	8 × 6.2	0.4	230
150	151				8 × 6.2	0.4	230			
220	221	8 × 6.2	0.4	230	8 × 10	0.3	450	10 × 10	0.15	670
330	331	8 × 10	0.3	450				10 × 10	0.15	670
470	471				10 × 10	0.15	670	10 × 10	0.15	670
680	681							10 × 10	0.15	670
1000	102	10 × 10	0.15	670	10 × 10	0.15	670			
1500	152	10 × 10	0.15	670						

Cap. (μF)	V	25			35			50		
		Code	1E		1V		1H		50	
1	010				4 × 5.4	3.0	60	4 × 5.4	5.0	30
2.2	2R2				4 × 5.4	3.0	60	4 × 5.4	5.0	30
3.3	3R3				4 × 5.4	3.0	60	4 × 5.4	5.0	30
4.7	4R7				4 × 5.4	3.0	60	5 × 5.4	3.0	50
6.8	6R8	4 × 5.4	3.0	60	5 × 5.4	1.8	95			
10	100				5 × 5.4	1.8	95	6.3 × 5.4	2.0	70
22	220	6.3 × 5.4	1.0	140	6.3 × 5.4	1.0	140	8 × 6.2	0.7	120
33	330	6.3 × 5.4	1.0	140	8 × 6.2	0.4	230	8 × 10	0.6	300
47	470	8 × 6.2	0.4	230	8 × 6.2	0.4	230	10 × 10	0.3	500
68	680	8 × 10	0.3	450						
100	101	8 × 10	0.3	450	10 × 10	0.15	670	10 × 10	0.3	500
220	221	10 × 10	0.15	670	10 × 10	0.15	670	10 × 10	0.3	500
330	331	10 × 10	0.15	670	10 × 10	0.15	670	Case size Φ D × L (mm)	Impedance	Rated ripple
470	471	10 × 10	0.15	670						

Max. Impedance (Ω) at 20°C 100kHz
Rated ripple current (mA rms) at 105°C 100kHz

● Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.35	0.50	0.64	0.83	1.00

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please select UUJ(p.158) if high C/V products are required.
- Please refer to page 3 for the minimum order quantity.